

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	IS&R	L1	5	((("5592025") or ("4460537")) or ("5132778") or ("5136366") or ("5153385")).PN.	USPAT	2005/03/16 13:27
2	BRS	L2	1384	(semiconductor or chip or die) and ((bump or ball) same heat) and ((bump or ball) same signal)	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:26
3	BRS	L3	22	("20010008305" "5220490" "5410107" "5508556" "5801440" "5818102" "5841191" "5864470" "5866942" "5894410" "5903050" "5982632" "6034427" "6037677" "6057596" "6104258" "6137168" "6198635" "6214638" "6268238" "6274925" "6278264").PN.	US- PGPUB; USPAT; USOCR	2005/03/16 13:59
4	BRS	L4	14	("5483099" "5490040" "5502278" "5545923" "5554881" "5640048" "5641988" "5691568" "5714801" "5717245" "5719439" "5719449" "5796170" "5955789").PN.	US- PGPUB; USPAT; USOCR	2005/03/16 14:12
5	BRS	L5	6	("6225702").URPN.	USPAT	2005/03/16 14:14
6	BRS	L6	9	("4642163" "4867839" "5011066" "5489750" "5973406" "6081038" "6142609" "6222277" "6225702").PN.	US- PGPUB; USPAT; USOCR	2005/03/16 14:15
7	BRS	L7	53	("5642261").URPN.	USPAT	2005/03/16 14:38
8	BRS	L8	0	("6829149").URPN.	USPAT	2005/03/16 14:39

	Comments	Error Definition	Errors
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9	BRS	L9	9	("5216278" "5285352" "5381307" "5598036" "5625222" "5641946" "5642261" "5745986" "5796169").PN.	US- PGPUB; USPAT; USOCR	2005/03/16 14:45
10	IS&R	L10	1	("5751198").PN.	USPAT	2005/03/16 14:59
11	BRS	L11	339	andoh.inv.	USPAT	2005/03/16 15:00
12	BRS	L12	13	("5285352" "5583377" "5642261" "5741729" "5825628" "5942795" "5959356" "6008536" "6023098" "6034427" "6038137" "6117705" "6125042").PN.	US- PGPUB; USPAT; USOCR	2005/03/16 15:06
13	BRS	L13	6	("6282094").URPN.	USPAT	2005/03/16 15:07
14	BRS	L14	111	(semiconductor or chip or die) and ((bump or ball) same heat same (solid same melt\$3))	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:32
15	BRS	L15	1	(semiconductor or chip or die) and ((bump or ball) same heat same (shorting same melt\$3))	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:33
16	BRS	L16	40	(semiconductor or chip or die) and ((bump or ball) same (shorting same melt\$3))	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:35

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	Type	L #	Hits	Search Text	DBs	Time Stamp
17	BRS	L17	706	(semiconductor or chip or die) and ((bump or ball) same (together same melt\$3))	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:38
18	BRS	L18	2	(semiconductor or chip or die) and ((bump or ball) same (thermally adj conductive) same (together same melt\$3))	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:44
19	BRS	L19	253	17 and cooling	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:38
20	BRS	L20	234	19 not 2	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:38
21	BRS	L21	9	(semiconductor or chip or die) and ((bump or ball) same (thermally adj conductive) same melted)	USPAT; EPO; JPO; DERWEN T; IBM_TD B	2005/03/16 15:44

	Comments	Error Definition	Errors
17			
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